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Dual N-channel 40 V, 19.5 mΩ logic level MOSFET

16 March 2016

Product data sheet

1. General description

Dual logic level N-channel MOSFET in an LFPAK56D (Dual Power-SO8) package using TrenchMOS technology. This product has been designed and qualified to AEC Q101 standard for use in high performance automotive applications.

2. Features and benefits

- Dual MOSFET
- Q101 Compliant
- Repetitive avalanche rated
- Suitable for thermally demanding environments due to 175 °C rating
- True logic level gate with $V_{GS(th)}$ rating of greater than 0.5 V at 175 °C

3. Applications

- 12 V Automotive systems
- Motors, lamps and solenoid control
- Transmission control
- Ultra high performance power switching

4. Quick reference data

Table 1. Quie	ck reference data									
Symbol	Parameter	Conditions		Min	Тур	Max	Unit			
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	-	40	V			
I _D	drain current	V _{GS} = 5 V; T _{mb} = 25 °C; <u>Fig. 2</u>		-	-	30	А			
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	-	38	W			
Static characteristics FET1 and FET2										
R _{DSon}	drain-source on-state resistance	V _{GS} = 5 V; I _D = 10 A; T _j = 25 °C; <u>Fig. 12</u>		-	17.1	19.5	mΩ			
Dynamic characteristics FET1 and FET2										
Q _{GD}	gate-drain charge	I_D = 10 A; V_{DS} = 32 V; V_{GS} = 10 V; T_j = 25 °C; <u>Fig. 14</u>		-	3	-	nC			

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5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S1	source1	8 7 6 5	
2	G1	gate1		
3	S2	source2	\bigcirc	
4	G2	gate2		
5	D2	drain2		 S1 G1 S2 G2
6	D2	drain2		mbk725
7	D1	drain1	1 2 3 4 LFPAK56D (SOT1205)	
8	D1	drain1	(0011200)	

6. Ordering information

Table 3. Ordering in	formation							
Type number	Package							
	Name	Description	Version					
BUK9K18-40E	LFPAK56D	Plastic single ended surface mounted package (LFPAK56D); 8 leads	SOT1205					

7. Marking

Table 4. Marking codes	
Type number	Marking code
BUK9K18-40E	91840E

8. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	40	V
V _{DGR}	drain-gate voltage	25 °C \leq T _j \leq 175 °C; R _{GS} = 20 k Ω		-	40	V
V_{GS}	gate-source voltage	DC; T _j ≤ 175 °C		-10	10	V
		Pulsed; T _j ≤ 175 °C	[1][<u>2]</u>	-15	15	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	38	W
I _D	drain current	V _{GS} = 5 V; T _{mb} = 25 °C; <u>Fig. 2</u>		-	30	А
		V _{GS} = 5 V; T _{mb} = 100 °C; <u>Fig. 2</u>		-	24	А
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BUK9K18-40E Product data sheet

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Symbol	Parameter	Conditions		Min	Max	Unit
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^\circ C$; Fig. 3	3	-	124	А
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
T _{sld(M)}	peak soldering temperature			-	260	°C
Source-drai	in diode FET1 and FET2					
I _S	source current	T _{mb} = 25 °C		-	30	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$		-	124	А
Avalanche I	Ruggedness FET1 and FET2					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$I_{D} = 30 \text{ A}; V_{sup} \le 40 \text{ V}; V_{GS} = 5 \text{ V};$ $T_{j(init)} = 25 \text{ °C}; \underline{Fig. 4}$	[3][4]	-	22	mJ

Accumulated Pulse duration up to 50 hours delivers zero defect ppm [1]

Significantly longer life times are achieved by lowering T_i and or V_{GS} . [2]

[3] [4] Refer to application note AN10273 for further information

Single-pulse avalanche rating limited by maximum junction temperature of 175 °C

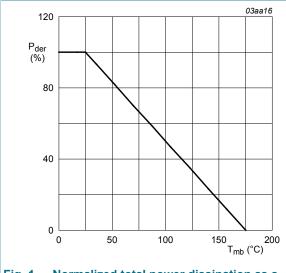
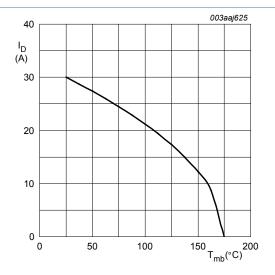


Fig. 1. Normalized total power dissipation as a function of mounting base temperature

$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$$

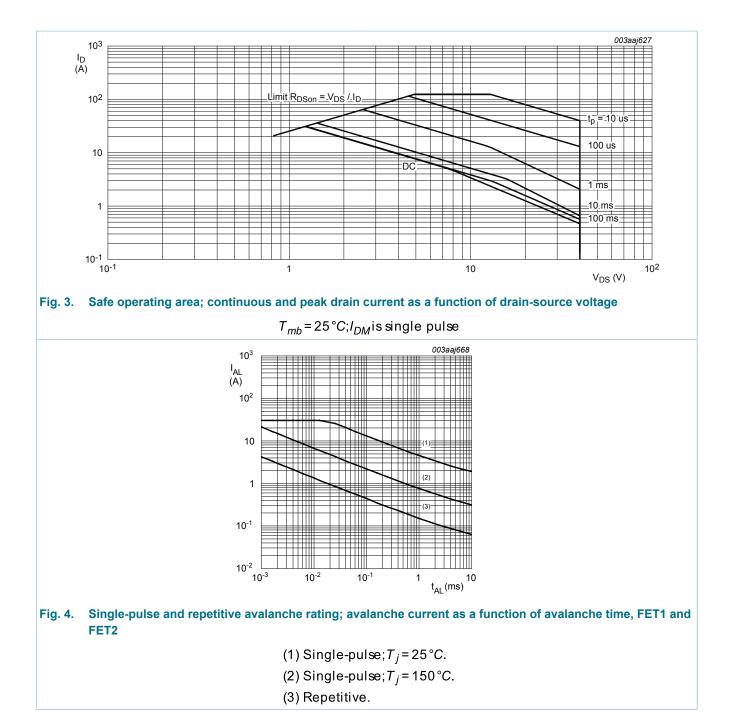




 $V_{GS} \ge 5V$

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9. Thermal characteristics

Table 6. The	rmal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. <u>5</u>	-	-	3.96	K/W

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1

t_p(s)

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10⁻¹

Symbol		Para	met	er			Cor	nditi	ons	;					Min	Ţ	ур	Мах	Unit
R _{th(j-a)} thermal resistance from junction to ambient			Minimum footprint; mounted on a printed circuit board				-	9	95	-	K/W								
10																		3aaj683	
Z _{th(j-mb)} (K/W)	_δ=	0.5								_			-	_					
1	0.2 0.1 0.05																		
10 ⁻¹	0.02	2			7										P	_	δ	$=\frac{t_p}{T}$	

10⁻³

10⁻²

Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

10-4

10. Characteristics

10⁻²

ngle shot

10⁻⁵

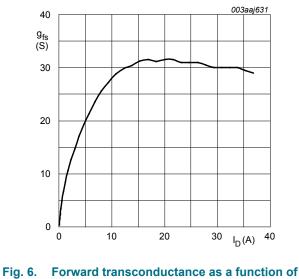
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics FET1 and FET2	· · · ·				
V _{(BR)DSS}	drain-source	I_D = 250 µA; V_{GS} = 0 V; T_j = -55 °C	36	-	-	V
	breakdown voltage	I_D = 250 µA; V_{GS} = 0 V; T_j = 25 °C	40	-	-	V
V _{GS(th)}	gate-source threshold voltage	I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 25 °C; Fig. 10; Fig. 11	1.4	1.7	2.1	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; Fig. 10; Fig. 11	0.5	-	-	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C; Fig. 10; Fig. 11	-	-	2.45	V
I _{DSS}	drain leakage current	V_{DS} = 40 V; V_{GS} = 0 V; T_j = 175 °C	-	-	500	μA
		V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C	-	0.02	1	μA
I _{GSS}	gate leakage current	V_{GS} = -10 V; V_{DS} = 0 V; T_j = 25 °C	-	2	100	nA
		V _{GS} = 10 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state	V_{GS} = 5 V; I _D = 10 A; T _j = 25 °C; <u>Fig. 12</u>	-	17.1	19.5	mΩ
	resistance	V _{GS} = 5 V; I _D = 10 A; T _j = 175 °C; Fig. 12; Fig. 13	-	34.37	39.2	mΩ

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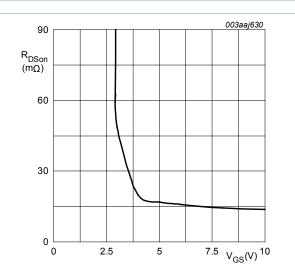
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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
		V _{GS} = 10 V; I _D = 10 A; T _j = 25 °C;	-	13.5	16	mΩ
		<u>Fig. 12</u>				
Dynamic cl	haracteristics FET1 and FE	T2				
Q _{G(tot)}	total gate charge	I_D = 10 A; V_{DS} = 32 V; V_{GS} = 10 V;	-	14.5	-	nC
		T _j = 25 °C; <u>Fig. 14; Fig. 15</u>				
Q _{GS}	gate-source charge	I_D = 10 A; V_{DS} = 32 V; V_{GS} = 10 V;	-	2	-	nC
Q _{GD}	gate-drain charge	T _j = 25 °C; <u>Fig. 14</u>	-	3	-	nC
C _{iss}	input capacitance	V_{DS} = 25 V; V_{GS} = 0 V; f = 1 MHz;	-	796	1061	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 16</u>	-	137	164	pF
C _{rss}	reverse transfer capacitance	-	-	82	112	pF
t _{d(on)}	turn-on delay time	V_{DS} = 32 V; R _L = 3.3 Ω; V _{GS} = 10 V;	-	4	-	ns
t _r	rise time	R _{G(ext)} = 5 Ω; T _j = 25 °C	-	4.6	-	ns
t _{d(off)}	turn-off delay time	-	-	17.5	-	ns
t _f	fall time		-	9.9	-	ns
Source-dra	in diode FET1 and FET2	· · · · ·				
V _{SD}	source-drain voltage	I_{S} = 10 A; V_{GS} = 0 V; T_{j} = 25 °C; <u>Fig. 17</u>	-	0.78	1.2	V
t _{rr}	reverse recovery time	I_{S} = 10 A; dI _S /dt = -100 A/µs; V _{GS} = 0 V;	-	8.3	-	ns
Q _r	recovered charge	V _{DS} = 20 V; T _j = 25 °C	-	16.2	-	nC



drain current; typical values

 $T_j = 25^{\circ}C; V_{DS} = 5V$

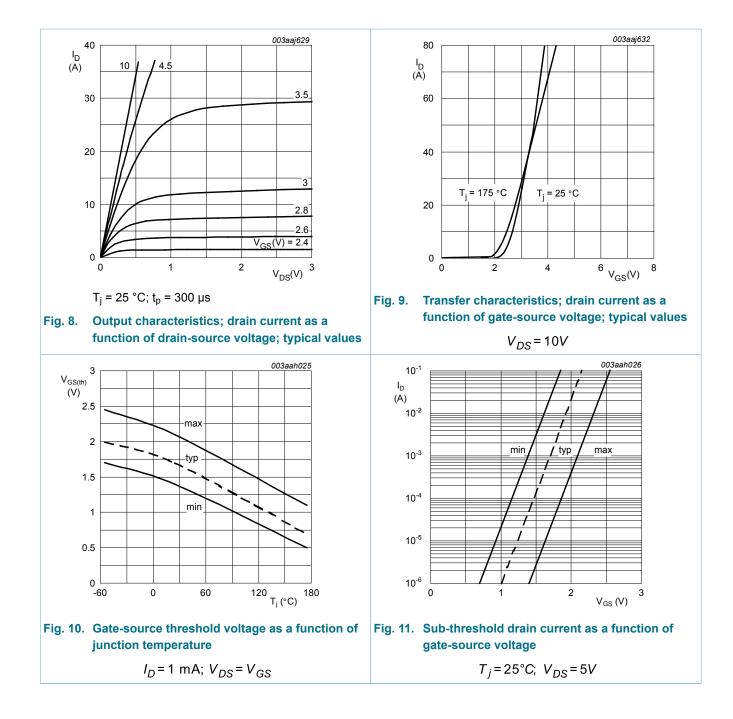




 $T_{i} = 25^{\circ}C; I_{D} = 10A$

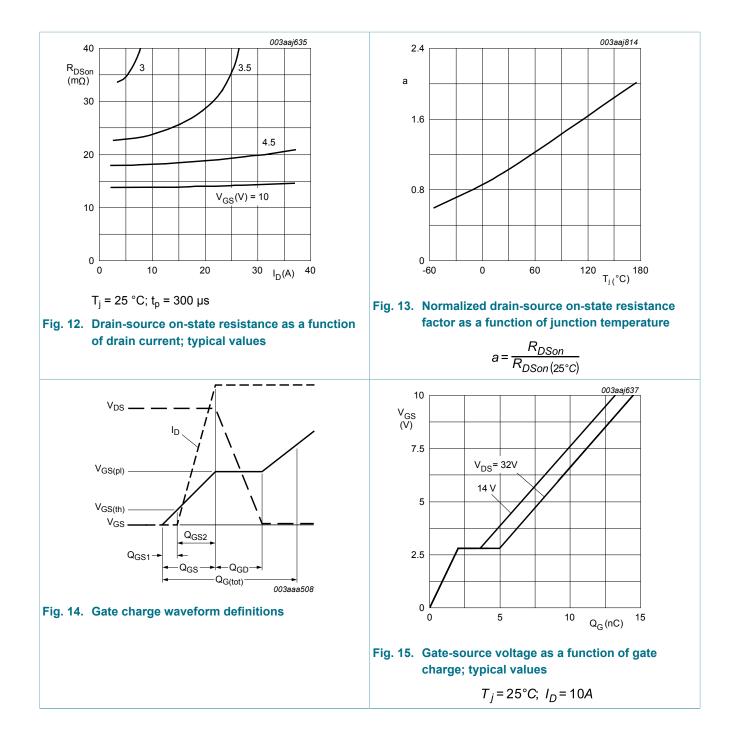
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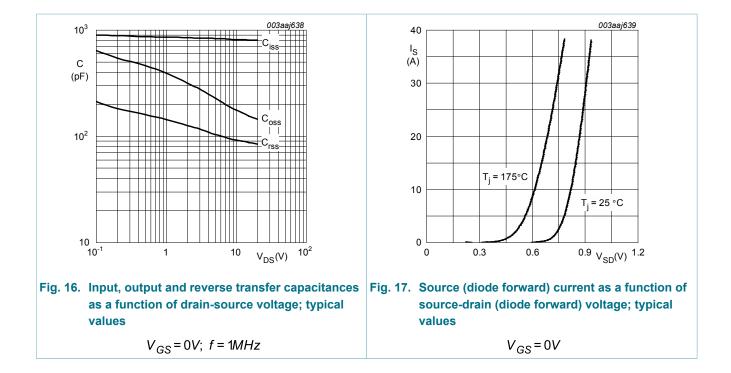
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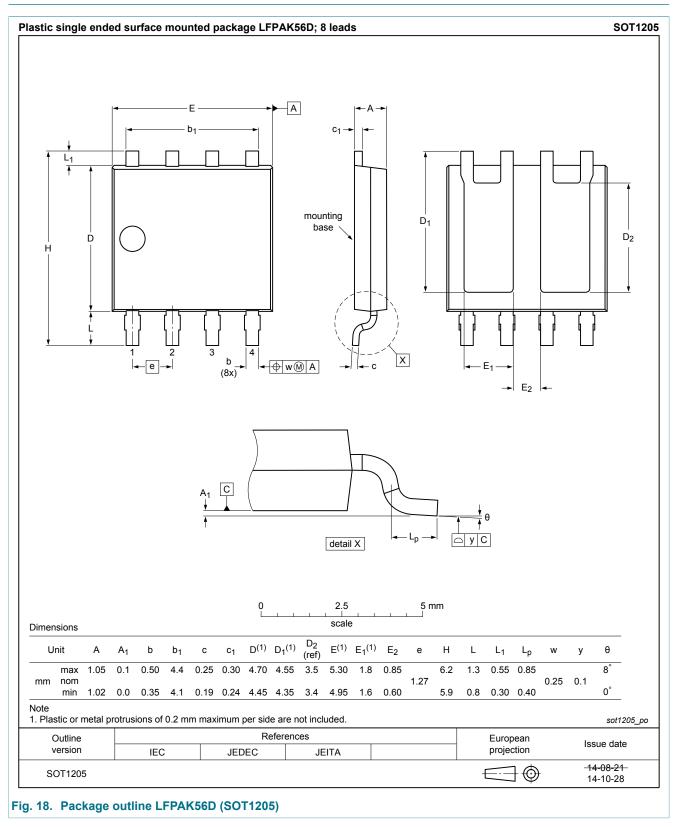
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11. Package outline



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12. Legal information

12.1 Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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